SK 80 MD 055



SEMITOP[®] 2

MOSFET Module

SK 80 MD 055

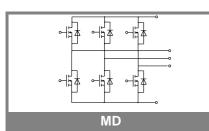
Target Data

Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonding aluminium oxide ceramic (DBC)
- Trench-gate technology
- Short internal connections and low inductance case

Typical Applications*

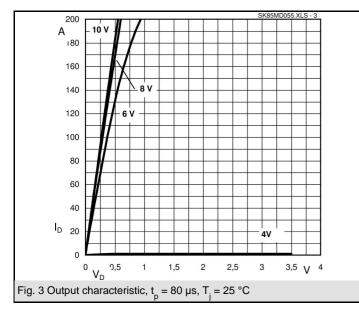
- Low power SMPS
- DC servo drives
- UPS
- 1) Maximum PCB temperature,
- at pins contact, = 85°C

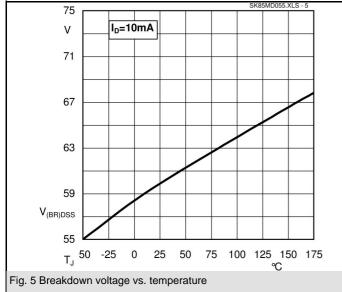


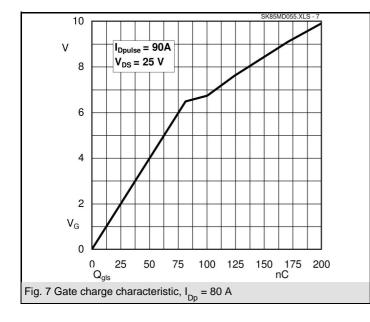
Absolute	Maximum Ratings	T_s = 25 °C, unless otherwise specified					
Symbol	Conditions	Values	Units				
MOSFET	55						
V _{DSS}		55	V				
V _{GSS}		± 20	V				
I _D	T _s = 25 (80) °C; 1)	117 (87)	А				
I _{DM}	t _p < 1 ms; T _s = 25 (80) °C;	234 (174)	А				
Т _ј		- 40 + 150	°C				
Inverse d							
	T _s = 25 (80) °C;	117 (87)	А				
$I_{FM} = -I_{DM}$	t _p < 1 ms; T _s = 25 (80) °C;	234 (174)	А				
Т _ј		- 40 + 150	°C				
Freewheeling CAL diode							
I _F = - I _D	T _s = °C		А				
Т _ј			°C				
T _{stg}		- 40 + 125	°C				
T _{sol}	Terminals, 10 s	260	°C				
V _{isol}	AC, 1 min (1s)	2500 / 3000	V				

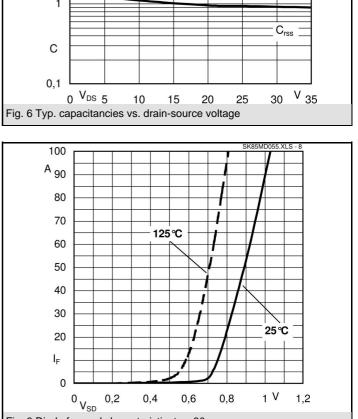
Characte	eristics	T _s = 25 °C,	unless of	herwise s	pecified	
Symbol	Conditions	min.	typ.	max.	Units	
MOSFET						
V _{(BR)DSS}	V _{GS} = 0 V, I _D = 0,25 mA	55			V	
V _{GS(th)}	$V_{GS} = V_{DS}; I_{D} = 0,25 \text{ mA}$	2,5	3,2	4,5	V	
IDSS	$V_{GS} = 0 \text{ V}; V_{DS} = V_{DSS}; T_{j} = 25 \text{ °C}$			1	μA	
I _{GSS}	$V_{GS} = \pm 20V$; $V_{DS} = 0V$			100	nA	
R _{DS(on)}	I_{D} = 20 A; V_{GS} = 10 V; T_{j} = 25 °C		2,2	2,9	mΩ	
R _{DS(on)}	I_{D} = 20 A; V_{GS} = 10 V; T_{j} = 125 °C		3,4		mΩ	
C _{CHC}	per MOSFET				pF	
C _{iss}	under following conditions:		10,6		nF	
C _{oss}	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz		1,65		nF	
C _{rss}			0,8		nF	
L _{DS}					nH	
t _{d(on)}	under following conditions:		35		ns	
t _r	V _{DD} = 30 V; V _{GS} = 10 V; I _D = 36 A		165		ns	
t _{d(off)}	$R_{G} = 2,5 \Omega$		70		ns	
t _f			105		ns	
R _{th(j-s)}	per MOSFET (per module)			1,1	K/W	
Inverse	diode				•	
V _{SD}	I _F = 50 A; V _{GS} = 0 V; T _j = 25 °C		0,9		V	
I _{RRM}	under following conditions:				А	
Q _{rr}	I _F = 85 A; T _{vj} = 25 °C; R _G = 56 Ω				μC	
t _{rr}	V _R = 65 A; di/dt = 100 A/µs				ns	
Free-wh	eeling diode	·				
V _F	$I_F = A; V_{GS} = V$				V	
I _{RRM}	under following conditions:				A	
Q _{rr}	I _F = A; T _{vj} = °C				μC	
t _{rr}	$V_r = A; di/dt = A/\mu s$				ns	
Mechanical data						
M1	mounting torque			2	Nm	
w			20		g	
Case	SEMITOP [®] 2		T 47			

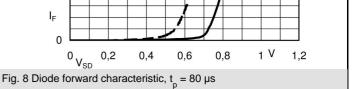
SK 80 MD 055

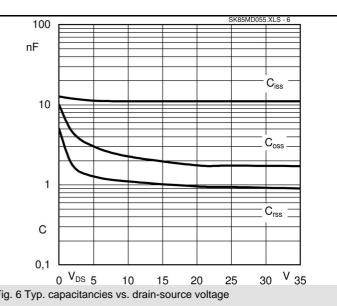




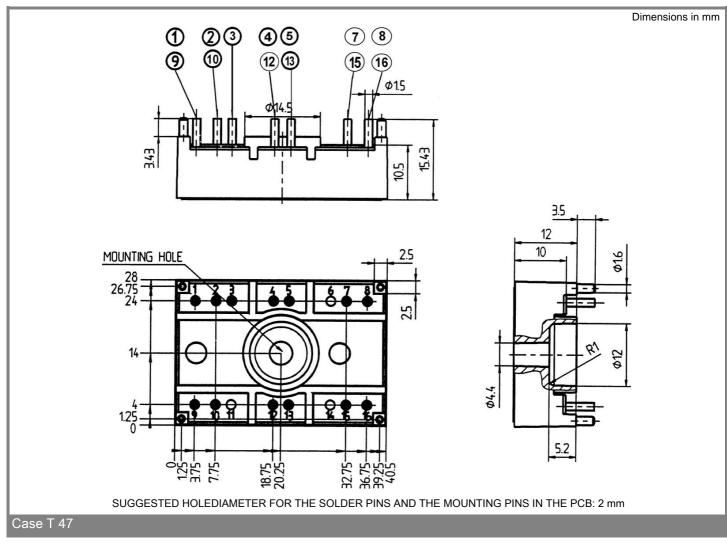


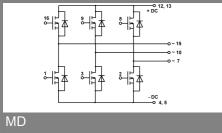






SK 80 MD 055





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.